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Understanding [Embedded - DSP \(Digital Signal Processors\)](#)

[Embedded - DSP \(Digital Signal Processors\)](#) are specialized microprocessors designed to perform complex mathematical computations on digital signals in real-time. Unlike general-purpose processors, DSPs are optimized for high-speed numeric processing tasks, making them ideal for applications that require efficient and precise manipulation of digital data. These processors are fundamental in converting and processing signals in various forms, including audio, video, and communication signals, ensuring that data is accurately interpreted and utilized in embedded systems.

Applications of [Embedded - DSP \(Digital Signal Processors\)](#)

Details

Product Status	Active
Type	Floating Point
Interface	CAN, EBI/EMI, Ethernet, DAI, I ² C, MMC/SD/SDIO, SPI, SPORT, UART/USART, USB OTG
Clock Rate	300MHz
Non-Volatile Memory	ROM (512kB)
On-Chip RAM	640kB
Voltage - I/O	3.30V
Voltage - Core	1.10V
Operating Temperature	-40°C ~ 95°C (TA)
Mounting Type	Surface Mount
Package / Case	349-LFBGA, CSPBGA
Supplier Device Package	349-CSPBGA (19x19)
Purchase URL	https://www.e-xfl.com/product-detail/analog-devices/adsp-sc584cbc-z-3a

ADSP-SC582/SC583/SC584/SC587/SC589/ADSP-21583/21584/21587

Table 2. Comparison of ADSP-SC58x/ADSP-2158x Processor Features

Processor Feature	ADSP-SC582	ADSP-SC583	ADSP-SC584	ADSP-SC587	ADSP-SC589	ADSP-21583	ADSP-21584	ADSP-21587
ARM Cortex-A5 (MHz, Max)	450	450	450	450	450	N/A	N/A	N/A
ARM Core L1 Cache (I, D kB)	32, 32	32, 32	32, 32	32, 32	32, 32	N/A	N/A	N/A
ARM Core L2 Cache (kB)	256	256	256	256	256	N/A	N/A	N/A
SHARC+ Core1 (MHz, Max)	450	450	450	450	450	450	450	450
SHARC+ Core2 (MHz, Max)	N/A	450	450	450	450	450	450	450
SHARC L1 SRAM/Core (kB)	640	384	640	640	640	384	640	640
System Memory	L2 SRAM (Shared) (kB)	256	256	256	256	256	256	256
	L2 ROM (Shared) (kB)	512	512	512	512	512	512	512
	DDR3/DDR2/LPDDR1 Controller (16-bit)	1	1	1	2	2	1	2
USB 2.0 HS + PHY (Host/Device/OTG)	1	1	1	1	1	N/A	N/A	N/A
USB 2.0 HS + PHY (Host/Device)	N/A	N/A	N/A	1	1	N/A	N/A	N/A
10/100 Std EMAC	N/A	N/A	N/A	1	1	N/A	N/A	N/A
10/100/1000 /AVB EMAC + Timer IEEE 1588	1	1	1	1	1	N/A	N/A	N/A
SDIO/eMMC	N/A	N/A	N/A	1	1	N/A	N/A	N/A
PCIe 2.0 (1 Lane)	N/A	N/A	N/A	N/A	1	N/A	N/A	N/A
RTC	N/A	N/A	N/A	1	1	N/A	N/A	1
GPIO Ports	Port A to E	Port A to E	Port A to E	Port A to G	Port A to G	Port A to E	Port A to E	Port A to G
GPIO + DAI Pins	80 + 28	80 + 28	80 + 28	102 + 40	102 + 40	80 + 28	80 + 28	102 + 40
19 mm × 19 mm Package Options	349-BGA	349-BGA	349-BGA	529-BGA	529-BGA	349-BGA	349-BGA	529-BGA

Table 3. Comparison of ADSP-SC58x/ADSP-2158x Processor Features for Automotive

Processor Feature	ADSP-SC582W	ADSP-SC583W	ADSP-SC584W	ADSP-SC587W	ADSP-21583W	ADSP-21584W
ARM Cortex-A5 (MHz, Max)	450	450	450	450	N/A	N/A
ARM Core L1 Cache (I, D kB)	32, 32	32, 32	32, 32	32, 32	N/A	N/A
ARM Core L2 Cache (kB)	256	256	256	256	N/A	N/A
SHARC+ Core1 (MHz, Max)	450	450	450	450	450	450
SHARC+ Core2 (MHz, Max)	N/A	450	450	450	450	450
SHARC L1 SRAM/Core (kB)	640	384	640	640	384	640
System Memory	L2 SRAM (Shared) (kB)	256	256	256	256	256
	L2 ROM (Shared) (kB)	512	512	512	512	512
	DDR3/DDR2/LPDDR1 Controller (16-bit)	1	1	1	2	1
USB 2.0 HS + PHY (Host/Device/OTG)	1	1	1	1	N/A	N/A
USB 2.0 HS + PHY (Host/Device)	N/A	N/A	N/A	1	N/A	N/A
10/100 Std EMAC	N/A	N/A	N/A	1	N/A	N/A
10/100/1000/AVB EMAC + Timer IEEE 1588	1	1	1	1	N/A	N/A
SDIO/eMMC	N/A	N/A	N/A	1	N/A	N/A
PCIe 2.0 (1 Lane)	N/A	N/A	N/A	N/A	N/A	N/A
MLB 3-Pin/6-Pin	1	1	1	1	1	1
RTC	N/A	N/A	N/A	1	N/A	N/A
GPIO Ports	Port A to E	Port A to E	Port A to E	Port A to G	Port A to E	Port A to E
GPIO + DAI Pins	80 + 28	80 + 28	80 + 28	102 + 40	80 + 28	80 + 28
19 mm × 19 mm Package Options	349-BGA	349-BGA	349-BGA	529-BGA	349-BGA	349-BGA

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Generic Interrupt Controller (GIC), PL390 (ADSP-SC58x Only)

The generic interrupt controller (GIC) is a centralized resource for supporting and managing interrupts. The GIC splits into the distributor block (GICPORT0) and the CPU interface block (GICPORT1).

Generic Interrupt Controller Port0 (GICPORT0)

The GICPORT0 distributor block performs interrupt prioritization and distribution to the GICPORT1 blocks that connect to the processors in the system. It centralizes all interrupt sources, determines the priority of each interrupt, and forwards the interrupt with the highest priority to the interface, for priority masking and preemption handling.

Generic Interrupt Controller Port1 (GICPORT1)

The GICPORT1 CPU interface block performs priority masking and preemption handling for a connected processor in the system. GICPORT1 supports 8 software generated interrupts (SGIs) and 254 shared peripheral interrupts (SPIs).

L2 Cache Controller, PL310 (ADSP-SC58x Only)

The L2 cache controller, PL310 (see [Figure 2](#)), works efficiently with the ARM Cortex-A5 processors that implement system fabric. The cache controller directly interfaces on the data and instruction interface. The internal pipelining of the cache controller is optimized to enable the processors to operate at the same clock frequency. The cache controller supports the following:

- Two read/write 64-bit slave ports, one connected to the ARM Cortex-A5 instruction and data interfaces, and one connecting the ARM Cortex-A5 and SHARC+ cores for data coherency.
- Two read/write 64-bit master ports for interfacing with the system fabric.

SHARC PROCESSOR

[Figure 3](#) shows the SHARC processor integrates a SHARC+ SIMD core, L1 memory crossbar, I/D cache controller, L1 memory blocks, and the master/slave ports. [Figure 4](#) shows the SHARC+ SIMD core block diagram.

The SHARC processor supports a modified Harvard architecture in combination with a hierarchical memory structure. L1 memories typically operate at the full processor speed with little or no latency.

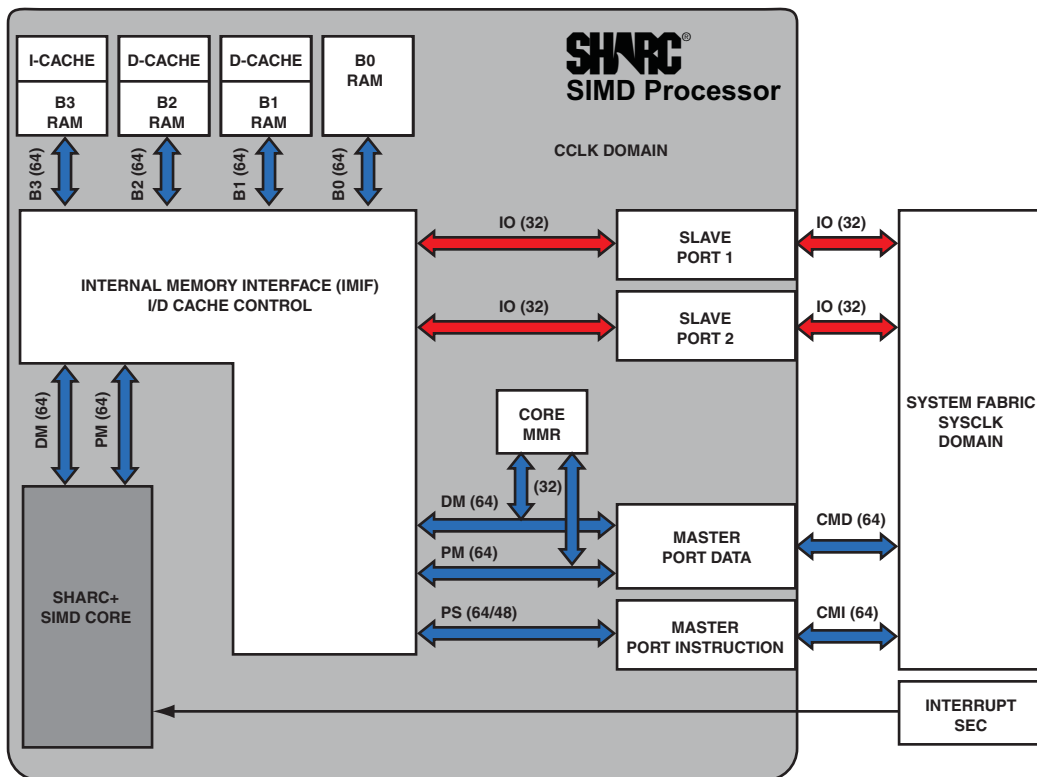


Figure 3. SHARC Processor Block Diagram

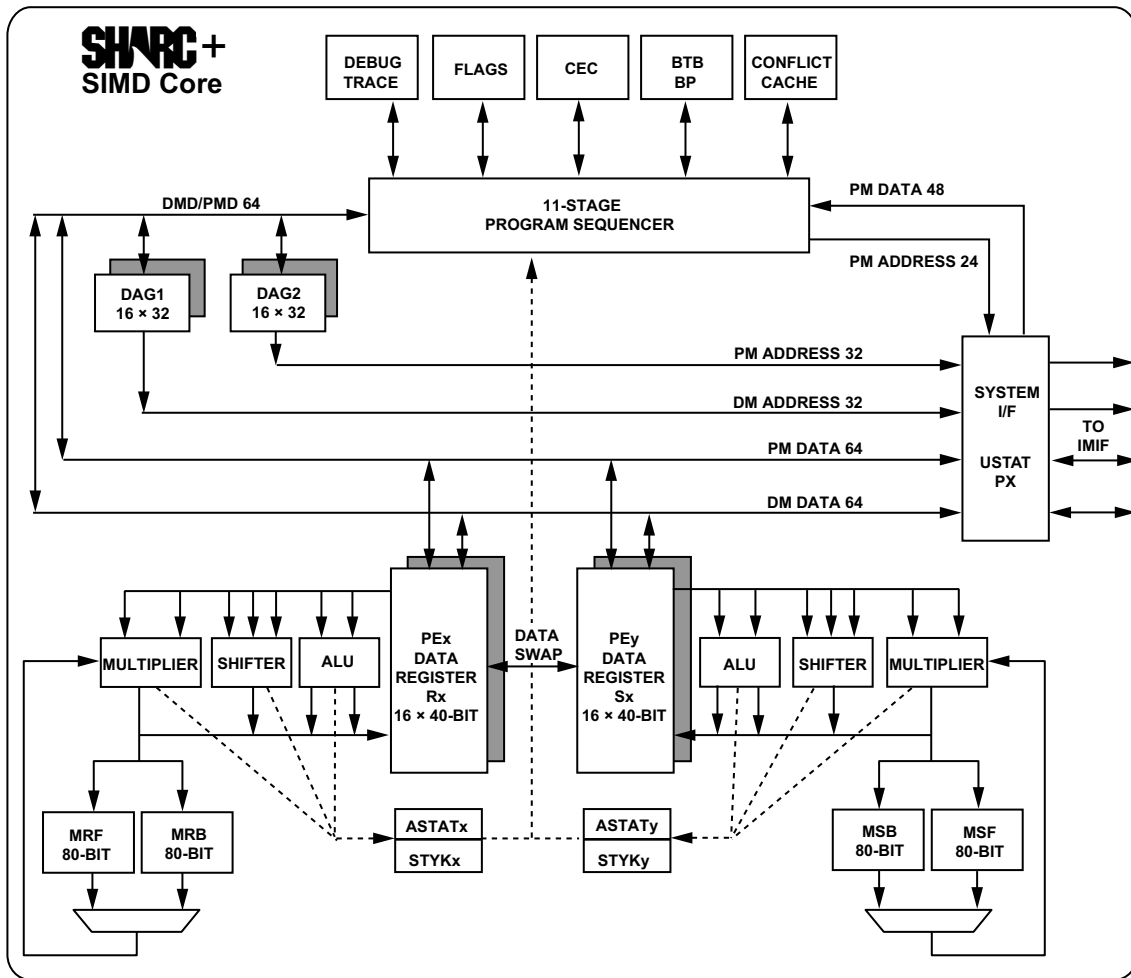


Figure 4. SHARC+ SIMD Core Block Diagram

L1 Memory

Figure 5 shows the ADSP-SC58x/ADSP-2158x memory map. Each SHARC+ core has a tightly coupled L1 SRAM of up to 5 Mb. Each SHARC+ core can access code and data in a single cycle from this memory space. The ARM Cortex-A5 core can also access this memory space with multicycle accesses.

In the SHARC+ core private address space, both cores have L1 memory.

SHARC+ core memory-mapped register (CMMR) address space is 0x 0000 0000 through 0x 0003 FFFF in Normal Word (32-bit). Each block can be configured for different combinations of code and data storage. Of the 5 Mb SRAM, up to 1024 Kb can be configured for data memory (DM), program memory (PM), and instruction cache. Each memory block supports single-cycle, independent accesses by the core processor and I/O processor. The memory architecture, in combination with its separate on-chip buses, allows two data transfers from the core and one from the DMA engine in a single cycle. The SRAM of the processor can be configured as a maximum of 160k words of 32-bit data, 320k words of 16-bit data, 106.7k words of 48-bit

instructions (or 40-bit data), or combinations of different word sizes up to 5 Mb. All of the memory can be accessed as 8-bit, 16-bit, 32-bit, 48-bit, or 64-bit words. Support of a 16-bit floating-point storage format doubles the amount of data that can be stored on chip.

Conversion between the 32-bit floating-point and 16-bit floating-point formats is performed in a single instruction. While each memory block can store combinations of code and data, accesses are most efficient when one block stores data using the DM bus for transfers, and the other block stores instructions and data using the PM bus for transfers.

Using the DM and PM buses, with each bus dedicated to a memory block, assures single-cycle execution with two data transfers. In this case, the instruction must be available in the cache. The system configuration is flexible, but a typical configuration is 512 Kb DM, 128 Kb PM, and 128 Kb of instruction cache, with the remaining L1 memory configured as SRAM. Each addressable memory space outside the L1 memory can be accessed either directly or via cache.

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Table 7. Memory Map of Mapped I/Os

	Byte Address Space ARM Cortex-A5 – Data Access and Instruction Fetch SHARC+ – Data Access	Normal Word Address Space for Data Access SHARC+	SHARC+ Core Instruction Fetch	
			VISA Space	ISA Space
SMC Bank 0 (64 MB)	0x40000000–0x43FFFFFF	0x01000000–0x01FFFFFF	0x00F00000–0x00F3FFFF	0x00700000–0x0073FFFF
SMC Bank 1 (64 MB)	0x44000000–0x47FFFFFF	Not applicable	Not applicable	Not applicable
SMC Bank 2 (64 MB)	0x48000000–0x4BFFFFFF	Not applicable	Not applicable	Not applicable
SMC Bank 3 (64 MB)	0x4C000000–0x4FFFFFFF	Not applicable	Not applicable	Not applicable
PCIe Data (256 MB)	0x50000000–0x5FFFFFFF	0x02000000–0x03FFFFFF	0x00F40000–0x00F7FFFF	0x00740000–0x0077FFFF
SPI2 Memory (512 MB)	0x60000000–0x7FFFFFFF	0x04000000–0x07FFFFFF	0x00F80000–0x00FFFFFF	0x00780000–0x007FFFFFFF

Table 8. DMC Memory Map

	Byte Address Space ARM Cortex-A5 – Data Access and Instruction Fetch SHARC+ – Data Access	Normal Word Address Space for Data Access SHARC+	SHARC+ Core Instruction Fetch	
			VISA Space	ISA Space
DMC0 (1 GB)	0x80000000–0xBFFFFFFF	0x10000000–0x17FFFFFFF	0x00800000–0x00AFFFFFFF	0x00400000–0x004FFFFFFF
DMC1 (1 GB)	0xC0000000–0xFFFFFFFF	0x18000000–0x1FFFFFFF	0x00C00000–0x00EFFFFFFF	0x00600000–0x006FFFFFFF

System Crossbars (SCBs)

The system crossbars (SCBs) are the fundamental building blocks of a switch-fabric style for on-chip system bus interconnection. The SCBs connect system bus masters to system bus slaves, providing concurrent data transfer between multiple bus masters and multiple bus slaves. A hierarchical model—built from multiple SCBs—provides a power and area efficient system interconnection.

The SCBs provide the following features:

- Highly efficient, pipelined bus transfer protocol for sustained throughput
- Full-duplex bus operation for flexibility and reduced latency
- Concurrent bus transfer support to allow multiple bus masters to access bus slaves simultaneously
- Protection model (privileged/secure) support for selective bus interconnect protection

Direct Memory Access (DMA)

The processors use direct memory access (DMA) to transfer data within memory spaces or between a memory space and a peripheral. The processors can specify data transfer operations and return to normal processing while the fully integrated DMA controller carries out the data transfers independent of processor activity.

DMA transfers can occur between memory and a peripheral or between one memory and another memory. Each memory to memory DMA stream uses two channels: one channel is the source channel and the second is the destination channel.

All DMA channels can transport data to and from all on-chip and off-chip memories. Programs can use two types of DMA transfers: descriptor-based or register-based.

Register-based DMA allows the processors to program DMA control registers directly to initiate a DMA transfer. On completion, the DMA control registers automatically update with original setup values for continuous transfer. Descriptor-based DMA transfers require a set of parameters stored within memory to initiate a DMA sequence. Descriptor-based DMA transfers allow multiple DMA sequences to be chained together. Program a DMA channel to set up and start another DMA transfer automatically after the current sequence completes.

The DMA engine supports the following DMA operations:

- A single linear buffer that stops on completion
- A linear buffer with negative, positive, or zero stride length
- A circular autorefreshing buffer that interrupts when each buffer becomes full
- A similar circular buffer that interrupts on fractional buffers, such as at the halfway point
- The 1D DMA uses a set of identical ping pong buffers defined by a linked ring of two-word descriptor sets, each containing a link pointer and an address
- The 1D DMA uses a linked list of four-word descriptor sets containing a link pointer, an address, a length, and a configuration
- The 2D DMA uses an array of one-word descriptor sets, specifying only the base DMA address
- The 2D DMA uses a linked list of multiword descriptor sets, specifying all configurable parameters

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CRC checksums can be calculated or compared automatically during memory transfers, or one or multiple memory regions can be continuously scrubbed by a single DMA work unit as per DMA descriptor chain instructions. The CRC engine also protects data loaded during the boot process.

Signal Watchdogs

The eight general-purpose timers feature modes to monitor off-chip signals. The watchdog period mode monitors whether external signals toggle with a period within an expected range. The watchdog width mode monitors whether the pulse widths of external signals are within an expected range. Both modes help to detect undesired toggling or lack of toggling of system level signals.

System Event Controller (SEC)

Besides system events, the system event controller (SEC) further supports fault management including fault action configuration as timeout, internal indication by system interrupt, or external indication through the `SYS_FAULT` pin and system reset.

PROCESSOR PERIPHERALS

The following sections describe the peripherals of the ADSP-SC58x/ADSP-2158x processors.

Dynamic Memory Controller (DMC)

The 16-bit dynamic memory controller (DMC) interfaces to:

- LPDDR1 (JESD209A) maximum frequency 200 MHz, DDRCLK (64 Mb to 2 Gb)
- DDR2 (JESD79-2E) maximum frequency 400 MHz, DDRCLK (256 Mb to 4 Gb)
- DDR3 (JESD79-3E) maximum frequency 450 MHz, DDRCLK (512 Mb to 8 Gb)
- DDR3L (1.5 V compatible only) maximum frequency 450 MHz, DDRCLK (512 Mb to 8 Gb)

See [Table 8](#) for the DMC memory map.

Digital Audio Interface (DAI)

The processors support two mirrored digital audio interface (DAI) units. Each DAI can connect various peripherals to any of the DAI pins (DAI_PIN20–DAI_PIN01).

The application code makes these connections using the signal routing unit (SRU), shown in [Figure 1](#).

The SRU is a matrix routing unit (or group of multiplexers) that enables the peripherals provided by the DAI to interconnect under software control. This functionality allows easy use of the DAI associated peripherals for a wider variety of applications by using a larger set of algorithms than is possible with nonconfigurable signal paths.

The DAI includes the peripherals described in the following sections (SPORTs, ASRC, S/PDIF, and PCG). DAI pin buffers 20 and 19 can change the polarity of the input signals. Most signals of the peripherals belonging to different DAIs cannot be interconnected, with few exceptions.

The DAI_PINx pin buffers may also be used as GPIO pins. DAI input signals allow the triggering of interrupts on the rising edge, the falling edge, or both edges.

See the Digital Audio Interface (DAI) chapter of the [ADSP-SC58x/ADSP-2158x SHARC+ Processor Hardware Reference](#) for complete information on the use of the DAIs and SRUs.

Serial Ports (SPORTs)

The processors feature eight synchronous full serial ports. These ports provide an inexpensive interface to a wide variety of digital and mixed-signal peripheral devices. These devices include Analog Devices AD19xx/ADAU19xx family of audio codecs, analog-to-digital converters (ADCs) and digital-to-analog converters (DACs). Two data lines, a clock, and frame sync make up the serial ports. The data lines can be programmed to either transmit or receive data and each data line has a dedicated DMA channel.

An individual full SPORT module consists of two independently configurable SPORT halves with identical functionality. Two bidirectional data lines—primary (0) and secondary (1)—are available per SPORT half and are configurable as either transmitters or receivers. Therefore, each SPORT half permits two unidirectional streams into or out of the same SPORT. This bidirectional functionality provides greater flexibility for serial communications. For full-duplex configuration, one half SPORT provides two transmit signals, while the other half SPORT provides the two receive signals. The frame sync and clock are shared.

Serial ports operate in the following six modes:

- Standard DSP serial mode
- Multichannel time division multiplexing (TDM) mode
- I²S mode
- Packed I²S mode
- Left justified mode
- Right justified mode

Asynchronous Sample Rate Converter (ASRC)

The asynchronous sample rate converter (ASRC) contains eight ASRC blocks. It is the same core in the AD1896 192 kHz stereo asynchronous sample rate converter. The ASRC provides up to 140 dB signal-to-noise ratio (SNR). The ASRC block performs synchronous or asynchronous sample rate conversion across independent stereo channels, without using internal processor resources. The ASRC blocks can also be configured to operate together to convert multichannel audio data without phase mismatches. Finally, the ASRC can clean up audio data from jittery clock sources such as the S/PDIF receiver.

S/PDIF-Compatible Digital Audio Receiver/Transmitter

The Sony/Philips Digital Interface Format (S/PDIF) is a standard audio data transfer format that allows the transfer of digital audio signals from one device to another without converting them to an analog signal. There are two S/PDIF transmit/receive

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Table 12. ADSP-SC58x/ADSP-2158x 349-Ball CSP_BGA Signal Descriptions (Continued)

Signal Name	Description	Port	Pin Name
PWM2_DL	PWM2 Channel D Low Side	E	PE_10
PWM2_SYNC	PWM2 PWMTMR Grouped	E	PE_05
PWM2_TRIP0	PWM2 Shutdown Input 0	D	PD_14
GND	Ground	Not Muxed	GND
VDD_EXT	External Voltage Domain	Not Muxed	VDD_EXT
VDD_INT	Internal Voltage Domain	Not Muxed	VDD_INT
SINC0_CLK0	SINC0 Clock 0	B	PB_01
SINC0_D0	SINC0 Data 0	A	PA_14
SINC0_D1	SINC0 Data 1	A	PA_15
SINC0_D2	SINC0 Data 2	B	PB_00
SINC0_D3	SINC0 Data 3	B	PB_04
SMC0_A01	SMC0 Address 1	B	PB_05
SMC0_A02	SMC0 Address 2	B	PB_06
SMC0_A03	SMC0 Address 3	B	PB_03
SMC0_A04	SMC0 Address 4	B	PB_02
SMC0_A05	SMC0 Address 5	D	PD_13
SMC0_A06	SMC0 Address 6	D	PD_12
SMC0_A07	SMC0 Address 7	B	PB_01
SMC0_A08	SMC0 Address 8	B	PB_00
SMC0_A09	SMC0 Address 9	A	PA_15
SMC0_A10	SMC0 Address 10	A	PA_14
SMC0_A11	SMC0 Address 11	A	PA_09
SMC0_A12	SMC0 Address 12	A	PA_08
SMC0_A13	SMC0 Address 13	A	PA_13
SMC0_A14	SMC0 Address 14	A	PA_12
SMC0_A15	SMC0 Address 15	A	PA_11
SMC0_A16	SMC0 Address 16	A	PA_07
SMC0_A17	SMC0 Address 17	A	PA_06
SMC0_A18	SMC0 Address 18	A	PA_05
SMC0_A19	SMC0 Address 19	A	PA_04
SMC0_A20	SMC0 Address 20	A	PA_01
SMC0_A21	SMC0 Address 21	A	PA_00
SMC0_A22	SMC0 Address 22	A	PA_10
SMC0_A23	SMC0 Address 23	A	PA_03
SMC0_A24	SMC0 Address 24	A	PA_02
SMC0_A25	SMC0 Address 25	C	PC_12
SMC0_ABE0	SMC0 Byte Enable 0	E	PE_14
SMC0_ABE1	SMC0 Byte Enable 1	E	PE_15
SMC0_AMS0	SMC0 Memory Select 0	C	PC_15
SMC0_AMS1	SMC0 Memory Select 1	E	PE_13
SMC0_AMS2	SMC0 Memory Select 2	C	PC_07
SMC0_AMS3	SMC0 Memory Select 3	C	PC_08
SMC0_AOE	SMC0 Output Enable	D	PD_01
SMC0_ARDY	SMC0 Asynchronous Ready	B	PB_04
SMC0_ARE	SMC0 Read Enable	C	PC_00
SMC0_AWE	SMC0 Write Enable	B	PB_15
SMC0_D00	SMC0 Data 0	E	PE_12
SMC0_D01	SMC0 Data 1	E	PE_11

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Table 12. ADSP-SC58x/ADSP-2158x 349-Ball CSP_BGA Signal Descriptions (Continued)

Signal Name	Description	Port	Pin Name
SYS_BMODE0	Boot Mode Control n	Not Muxed	SYS_BMODE0
SYS_BMODE1	Boot Mode Control n	Not Muxed	SYS_BMODE1
SYS_BMODE2	Boot Mode Control n	Not Muxed	SYS_BMODE2
SYS_CLKIN0	Clock/Crystal Input	Not Muxed	SYS_CLKIN0
SYS_CLKIN1	Clock/Crystal Input	Not Muxed	SYS_CLKIN1
SYS_CLKOUT	Processor Clock Output	Not Muxed	SYS_CLKOUT
SYS_FAULT	Active High Fault Output	Not Muxed	SYS_FAULT
$\overline{\text{SYS_FAULT}}$	Active Low Fault Output	Not Muxed	$\overline{\text{SYS_FAULT}}$
$\overline{\text{SYS_HWRST}}$	Processor Hardware Reset Control	Not Muxed	$\overline{\text{SYS_HWRST}}$
$\overline{\text{SYS_RESOUT}}$	Reset Output	Not Muxed	$\overline{\text{SYS_RESOUT}}$
SYS_XTAL0	Crystal Output	Not Muxed	SYS_XTAL0
SYS_XTAL1	Crystal Output	Not Muxed	SYS_XTAL1
TMO_ACIO	TIMERO Alternate Capture Input 0	C	PC_14
TMO_AC11	TIMERO Alternate Capture Input 1	B	PB_03
TMO_AC12	TIMERO Alternate Capture Input 2	D	PD_13
TMO_AC13	TIMERO Alternate Capture Input 3	C	PC_07
TMO_AC14	TIMERO Alternate Capture Input 4	B	PB_10
TMO_ACLK1	TIMERO Alternate Clock 1	D	PD_08
TMO_ACLK2	TIMERO Alternate Clock 2	D	PD_09
TMO_ACLK3	TIMERO Alternate Clock 3	B	PB_00
TMO_ACLK4	TIMERO Alternate Clock 4	B	PB_01
TMO_CLK	TIMERO Clock	C	PC_11
TMO_TMR0	TIMERO Timer 0	E	PE_09
TMO_TMR1	TIMERO Timer 1	B	PB_15
TMO_TMR2	TIMERO Timer 2	B	PB_10
TMO_TMR3	TIMERO Timer 3	B	PB_07
TMO_TMR4	TIMERO Timer 4	B	PB_08
TMO_TMR5	TIMERO Timer 5	B	PB_14
TRACE0_CLK	TRACE0 Trace Clock	D	PD_10
TRACE0_D00	TRACE0 Trace Data 0	D	PD_02
TRACE0_D01	TRACE0 Trace Data 1	D	PD_03
TRACE0_D02	TRACE0 Trace Data 2	D	PD_04
TRACE0_D03	TRACE0 Trace Data 3	D	PD_05
TRACE0_D04	TRACE0 Trace Data 4	D	PD_06
TRACE0_D05	TRACE0 Trace Data 5	D	PD_07
TRACE0_D06	TRACE0 Trace Data 6	D	PD_08
TRACE0_D07	TRACE0 Trace Data 7	D	PD_09
TWI0_SCL	TWI0 Serial Clock	Not Muxed	TWI0_SCL
TWI0_SDA	TWI0 Serial Data	Not Muxed	TWI0_SDA
TWI1_SCL	TWI1 Serial Clock	Not Muxed	TWI1_SCL
TWI1_SDA	TWI1 Serial Data	Not Muxed	TWI1_SDA
TWI2_SCL	TWI2 Serial Clock	Not Muxed	TWI2_SCL
TWI2_SDA	TWI2 Serial Data	Not Muxed	TWI2_SDA
$\overline{\text{UART0_CTS}}$	UART0 Clear to Send	D	PD_00
$\overline{\text{UART0_RTS}}$	UART0 Request to Send	C	PC_15
$\overline{\text{UART0_RX}}$	UART0 Receive	C	PC_14
$\overline{\text{UART0_TX}}$	UART0 Transmit	C	PC_13
$\overline{\text{UART1_CTS}}$	UART1 Clear to Send	E	PE_01

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Table 19. ADSP-SC58x/ADSP-2158x 529-Ball CSP_BGA Signal Descriptions (Continued)

Signal Name	Description	Port	Pin Name
PPIO_D00	EPPIO Data 0	E	PE_12
PPIO_D01	EPPIO Data 1	E	PE_11
PPIO_D02	EPPIO Data 2	E	PE_10
PPIO_D03	EPPIO Data 3	E	PE_09
PPIO_D04	EPPIO Data 4	E	PE_08
PPIO_D05	EPPIO Data 5	E	PE_07
PPIO_D06	EPPIO Data 6	E	PE_06
PPIO_D07	EPPIO Data 7	E	PE_05
PPIO_D08	EPPIO Data 8	E	PE_04
PPIO_D09	EPPIO Data 9	E	PE_00
PPIO_D10	EPPIO Data 10	D	PD_15
PPIO_D11	EPPIO Data 11	D	PD_14
PPIO_D12	EPPIO Data 12	B	PB_04
PPIO_D13	EPPIO Data 13	B	PB_05
PPIO_D14	EPPIO Data 14	B	PB_00
PPIO_D15	EPPIO Data 15	B	PB_01
PPIO_D16	EPPIO Data 16	B	PB_02
PPIO_D17	EPPIO Data 17	B	PB_03
PPIO_D18	EPPIO Data 18	D	PD_13
PPIO_D19	EPPIO Data 19	D	PD_12
PPIO_D20	EPPIO Data 20	E	PE_13
PPIO_D21	EPPIO Data 21	E	PE_14
PPIO_D22	EPPIO Data 22	E	PE_15
PPIO_D23	EPPIO Data 23	D	PD_00
PPIO_FS1	EPPIO Frame Sync 1 (HSYNC)	E	PE_02
PPIO_FS2	EPPIO Frame Sync 2 (VSYNC)	E	PE_01
PPIO_FS3	EPPIO Frame Sync 3 (FIELD)	C	PC_15
PWM0_AH	PWM0 Channel A High Side	B	PB_07
PWM0_AL	PWM0 Channel A Low Side	B	PB_08
PWM0_BH	PWM0 Channel B High Side	B	PB_06
PWM0_BL	PWM0 Channel B Low Side	C	PC_00
PWM0_CH	PWM0 Channel C High Side	B	PB_13
PWM0_CL	PWM0 Channel C Low Side	B	PB_14
PWM0_DH	PWM0 Channel D High Side	B	PB_11
PWM0_DL	PWM0 Channel D Low Side	B	PB_12
PWM0_SYNC	PWM0 PWMTMR Grouped	E	PE_09
PWM0_TRIP0	PWM0 Shutdown Input 0	B	PB_15
PWM1_AH	PWM1 Channel A High Side	D	PD_03
PWM1_AL	PWM1 Channel A Low Side	D	PD_04
PWM1_BH	PWM1 Channel B High Side	D	PD_05
PWM1_BL	PWM1 Channel B Low Side	D	PD_06
PWM1_CH	PWM1 Channel C High Side	D	PD_07
PWM1_CL	PWM1 Channel C Low Side	D	PD_08
PWM1_DH	PWM1 Channel D High Side	D	PD_09
PWM1_DL	PWM1 Channel D Low Side	D	PD_10
PWM1_SYNC	PWM1 PWMTMR Grouped	D	PD_11
PWM1_TRIP0	PWM1 Shutdown Input 0	D	PD_02
PWM2_AH	PWM2 Channel A High Side	F	PF_07

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Table 19. ADSP-SC58x/ADSP-2158x 529-Ball CSP_BGA Signal Descriptions (Continued)

Signal Name	Description	Port	Pin Name
TRACE0_D03	TRACE0 Trace Data (first instance)	G	PG_01
TRACE0_D03	TRACE0 Trace Data 3 (second instance)	D	PD_05
TRACE0_D04	TRACE0 Trace Data (first instance)	G	PG_02
TRACE0_D04	TRACE0 Trace Data 4 (second instance)	D	PD_06
TRACE0_D05	TRACE0 Trace Data 5 (first instance)	D	PD_07
TRACE0_D05	TRACE0 Trace Data (second instance)	G	PG_03
TRACE0_D06	TRACE0 Trace Data (first instance)	G	PG_04
TRACE0_D06	TRACE0 Trace Data 6 (second instance)	D	PD_08
TRACE0_D07	TRACE0 Trace Data (first instance)	G	PG_05
TRACE0_D07	TRACE0 Trace Data 7 (second instance)	D	PD_09
TRACE0_D08	TRACE0 Trace Data 8	F	PF_13
TRACE0_D09	TRACE0 Trace Data 9	F	PF_14
TRACE0_D10	TRACE0 Trace Data 10	F	PF_15
TRACE0_D11	TRACE0 Trace Data 11	G	PG_01
TRACE0_D12	TRACE0 Trace Data 12	G	PG_02
TRACE0_D13	TRACE0 Trace Data 13	G	PG_03
TRACE0_D14	TRACE0 Trace Data 14	G	PG_04
TRACE0_D15	TRACE0 Trace Data 15	G	PG_05
TWI0_SCL	TWI0 Serial Clock	Not Muxed	TWI0_SCL
TWI0_SDA	TWI0 Serial Data	Not Muxed	TWI0_SDA
TWI1_SCL	TWI1 Serial Clock	Not Muxed	TWI1_SCL
TWI1_SDA	TWI1 Serial Data	Not Muxed	TWI1_SDA
TWI2_SCL	TWI2 Serial Clock	Not Muxed	TWI2_SCL
TWI2_SDA	TWI2 Serial Data	Not Muxed	TWI2_SDA
<u>UART0_CTS</u>	UART0 Clear to Send	D	PD_00
<u>UART0_RTS</u>	UART0 Request to Send	C	PC_15
<u>UART0_RX</u>	UART0 Receive	C	PC_14
<u>UART0_TX</u>	UART0 Transmit	C	PC_13
<u>UART1_CTS</u>	UART1 Clear to Send	E	PE_01
<u>UART1_RTS</u>	UART1 Request to Send	E	PE_02
<u>UART1_RX</u>	UART1 Receive	B	PB_03
<u>UART1_TX</u>	UART1 Transmit	B	PB_02
<u>UART2_CTS</u>	UART2 Clear to Send	E	PE_11
<u>UART2_RTS</u>	UART2 Request to Send	E	PE_10
<u>UART2_RX</u>	UART2 Receive	D	PD_13
<u>UART2_TX</u>	UART2 Transmit	D	PD_12
USB0_CLKIN	USB0 Clock/Crystal Input	Not Muxed	USB_CLKIN
USB0_DM	USB0 Data -	Not Muxed	USB0_DM
USB0_DP	USB0 Data +	Not Muxed	USB0_DP
USB0_ID	USB0 OTG ID	Not Muxed	USB0_ID
USB0_VBC	USB0 VBUS Control	Not Muxed	USB0_VBC
USB0_VBUS	USB0 Bus Voltage	Not Muxed	USB0_VBUS
USB0_XTAL	USB0 Crystal	Not Muxed	USB_XTAL
USB1_DM	USB1 Data -	Not Muxed	USB1_DM
USB1_DP	USB1 Data +	Not Muxed	USB1_DP
USB1_VBUS	USB1 Bus Voltage	Not Muxed	USB1_VBUS
VDD_DMC	DMC VDD	Not Muxed	VDD_DMC
VDD_HADC	HADC VDD	Not Muxed	VDD_HADC

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Table 19. ADSP-SC58x/ADSP-2158x 529-Ball CSP_BGA Signal Descriptions (Continued)

Signal Name	Description	Port	Pin Name
VDD_PCIE	PCIE Supply Voltage	Not Muxed	VDD_PCIE
VDD_PCIE_RX	PCIE RX Supply Voltage	Not Muxed	VDD_PCIE_RX
VDD_PCIE_TX	PCIE TX Supply Voltage	Not Muxed	VDD_PCIE_TX
VDD_RTC	RTC VDD	Not Muxed	VDD_RTC
VDD_USB	USB VDD	Not Muxed	VDD_USB

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Table 27. ADSP-SC58x/ADSP-2158x Designer Quick Reference (Continued)

Signal Name	Type	Driver Type	Int Term	Reset Term	Reset Drive	Power Domain	Description and Notes
$\overline{\text{DMC0_UDQS}}$	InOut	C	Internal logic ensures that input signal does not float	none	none	VDD_DMC	Desc: DMC0 Data Strobe for Upper Byte (complement) Notes: No notes
DMC0_VREF	a		none	none	none	VDD_DMC	Desc: DMC0 Voltage Reference Notes: No notes
$\overline{\text{DMC0_WE}}$	Output	B	none	none	none	VDD_DMC	Desc: DMC0 Write Enable Notes: No notes
DMC1_A00	Output	B	none	none	none	VDD_DMC	Desc: DMC1 Address 0 Notes: No notes
DMC1_A01	Output	B	none	none	none	VDD_DMC	Desc: DMC1 Address 1 Notes: No notes
DMC1_A02	Output	B	none	none	none	VDD_DMC	Desc: DMC1 Address 2 Notes: No notes
DMC1_A03	Output	B	none	none	none	VDD_DMC	Desc: DMC1 Address 3 Notes: No notes
DMC1_A04	Output	B	none	none	none	VDD_DMC	Desc: DMC1 Address 4 Notes: No notes
DMC1_A05	Output	B	none	none	none	VDD_DMC	Desc: DMC1 Address 5 Notes: No notes
DMC1_A06	Output	B	none	none	none	VDD_DMC	Desc: DMC1 Address 6 Notes: No notes
DMC1_A07	Output	B	none	none	none	VDD_DMC	Desc: DMC1 Address 7 Notes: No notes
DMC1_A08	Output	B	none	none	none	VDD_DMC	Desc: DMC1 Address 8 Notes: No notes
DMC1_A09	Output	B	none	none	none	VDD_DMC	Desc: DMC1 Address 9 Notes: No notes
DMC1_A10	Output	B	none	none	none	VDD_DMC	Desc: DMC1 Address 10 Notes: No notes
DMC1_A11	Output	B	none	none	none	VDD_DMC	Desc: DMC1 Address 11 Notes: No notes
DMC1_A12	Output	B	none	none	none	VDD_DMC	Desc: DMC1 Address 12 Notes: No notes
DMC1_A13	Output	B	none	none	none	VDD_DMC	Desc: DMC1 Address 13 Notes: No notes
DMC1_A14	Output	B	none	none	none	VDD_DMC	Desc: DMC1 Address 14 Notes: No notes
DMC1_A15	Output	B	none	none	none	VDD_DMC	Desc: DMC1 Address 15 Notes: No notes
DMC1_BA0	Output	B	none	none	none	VDD_DMC	Desc: DMC1 Bank Address Input 0 Notes: No notes
DMC1_BA1	Output	B	none	none	none	VDD_DMC	Desc: DMC1 Bank Address Input 1 Notes: No notes

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Table 27. ADSP-SC58x/ADSP-2158x Designer Quick Reference (Continued)

Signal Name	Type	Driver Type	Int Term	Reset Term	Reset Drive	Power Domain	Description and Notes
PA_15	InOut	A	PullDown	none	none	VDD_EXT	Desc: PORTA Position 15 EMAC0 PTP Pulse-Per-Second Output 2 SINC0 Data 1 SMC0 Address 9 Notes: No notes
PB_00	InOut	A	PullDown	none	none	VDD_EXT	Desc: PORTB Position 0 EMAC0 PTP Pulse-Per-Second Output 1 EPPI0 Data 14 SINC0 Data 2 SMC0 Address 8 TIMER0 Alternate Clock 3 Notes: No notes
PB_01	InOut	A	PullDown	none	none	VDD_EXT	Desc: PORTB Position 1 EMAC0 PTP Pulse-Per-Second Output 0 EPPI0 Data 15 SINC0 Clock 0 SMC0 Address 7 TIMER0 Alternate Clock 4 Notes: No notes
PB_02	InOut	A	PullDown	none	none	VDD_EXT	Desc: PORTB Position 2 EMAC0 PTP Clock Input 0 EPPI0 Data 16 SMC0 Address 4 UART1 Transmit Notes: No notes
PB_03	InOut	A	PullDown	none	none	VDD_EXT	Desc: PORTB Position 3 EMAC0 PTP Auxiliary Trigger Input 0 EPPI0 Data 17 SMC0 Address 3 UART1 Receive TIMER0 Alternate Capture Input 1 Notes: No notes
PB_04	InOut	A	PullDown	none	none	VDD_EXT	Desc: PORTB Position 4 EPPI0 Data 12 MLB0 Single-Ended Clock SINC0 Data 3 SMC0 Asynchronous Ready EMAC0 PTP Auxiliary Trigger Input 1 Notes: No notes
PB_05	InOut	A	PullDown	none	none	VDD_EXT	Desc: PORTB Position 5 EPPI0 Data 13 MLB0 Single-Ended Signal SMC0 Address 1 EMAC0 PTP Auxiliary Trigger Input 2 Notes: No notes
PB_06	InOut	A	PullDown	none	none	VDD_EXT	Desc: PORTB Position 6 MLB0 Single-Ended Data PWM0 Channel B High Side SMC0 Address 2 EMAC0 PTP Auxiliary Trigger Input 3 Notes: No notes
PB_07	InOut	A	PullDown	none	none	VDD_EXT	Desc: PORTB Position 7 LP1 Data 0 PWM0 Channel A High Side SMC0 Data 15 TIMER0 Timer 3 Notes: No notes
PB_08	InOut	A	PullDown	none	none	VDD_EXT	Desc: PORTB Position 8 LP1 Data 1 PWM0 Channel A Low Side SMC0 Data 14 TIMER0 Timer 4 Notes: No notes

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Table 30. Phase-Locked Loop (PLL) Operating Conditions

Parameter		Min	Max	Unit
f_{PLLCLK}	PLL Clock Frequency	250	900	MHz

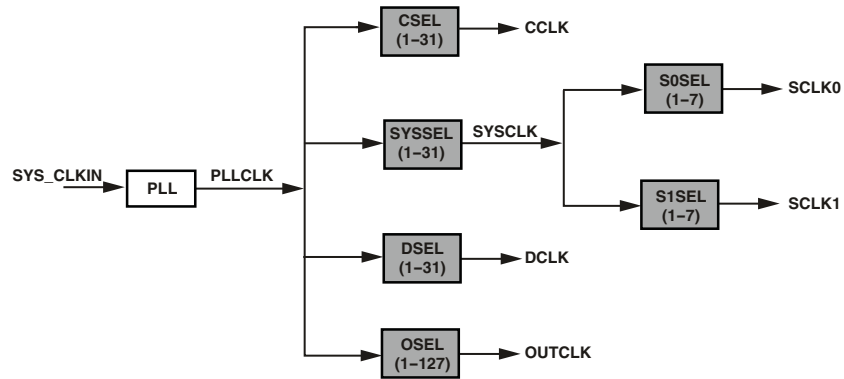


Figure 8. Clock Relationships and Divider Values

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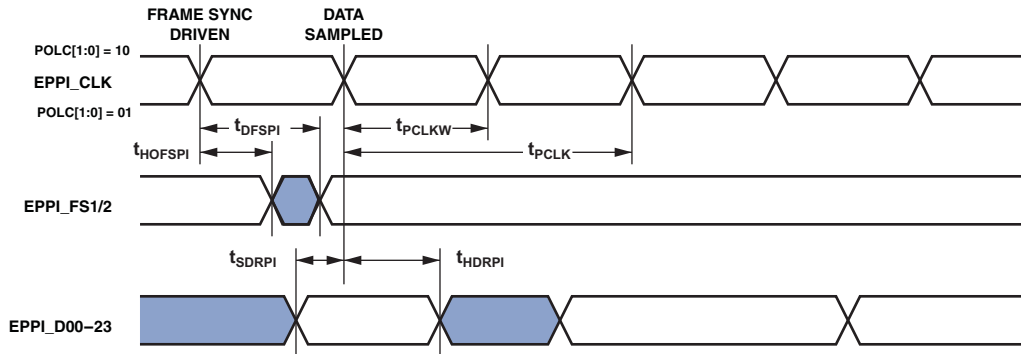


Figure 26. EPPI Internal Clock GP Receive Mode with Internal Frame Sync Timing

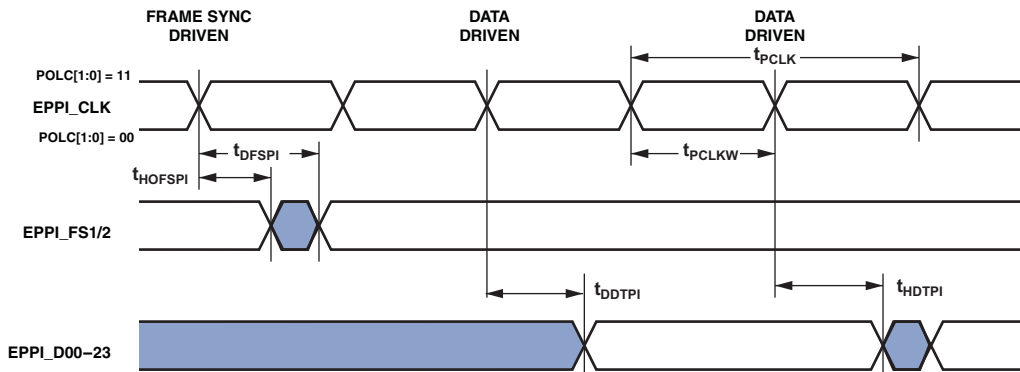


Figure 27. EPPI Internal Clock GP Transmit Mode with Internal Frame Sync Timing

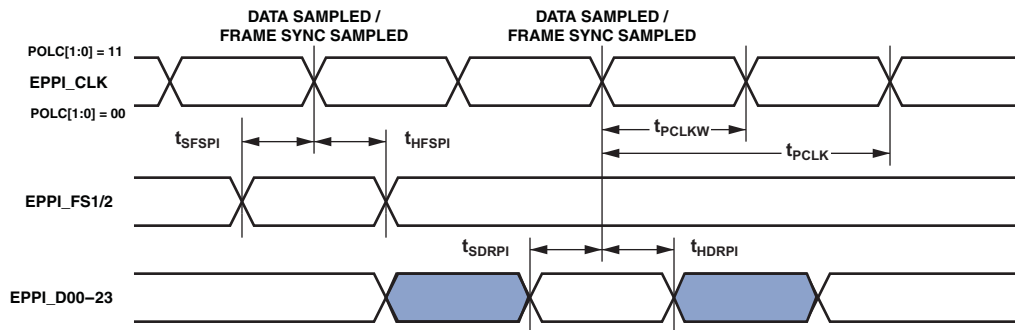


Figure 28. EPPI Internal Clock GP Receive Mode with External Frame Sync Timing

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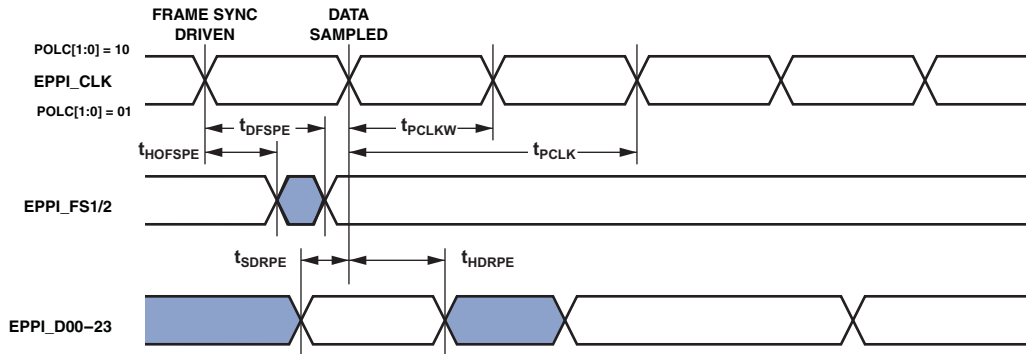


Figure 31. EPPI External Clock GP Receive Mode with Internal Frame Sync Timing

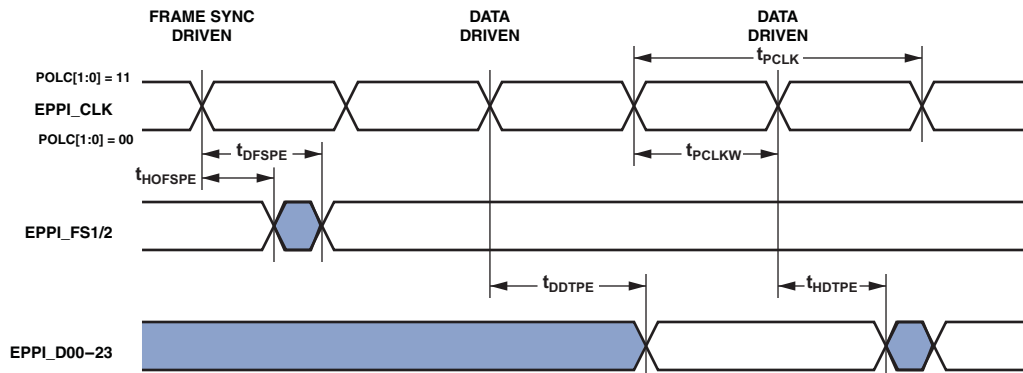


Figure 32. EPPI External Clock GP Transmit Mode with Internal Frame Sync Timing

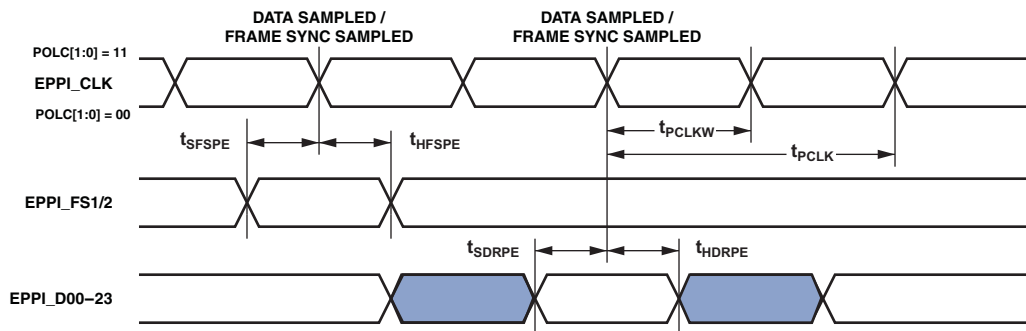


Figure 33. EPPI External Clock GP Receive Mode with External Frame Sync Timing

ADSP-SC582/SC583/SC584/SC587/SC589/ADSP-21583/21584/21587

SPI Port—Slave Timing

Table 72 and Figure 44 describe SPI port slave operations. Note that

- In dual-mode data transmit, the SPIx_MOSI signal is also an output.
- In quad-mode data transmit, the SPIx_MOSI, SPIx_D2, and SPIx_D3 signals are also outputs.
- In dual-mode data receive, the SPIx_MISO signal is also an input.
- In quad-mode data receive, the SPIx_MISO, SPIx_D2, and SPIx_D3 signals are also inputs.
- In SPI slave mode, the SPI clock is supplied externally and is called $f_{SPICLKEXT}$:

$$t_{SPICLKEXT} = \frac{1}{f_{SPICLKEXT}}$$

- Quad mode is supported by SPI2 only.
- CPHA is a configuration bit in the SPI_CTL register.

Table 72. SPI Port—Slave Timing¹

Parameter	Min	Max	Unit
<i>Timing Requirements</i>			
t _{SPICHS} SPIx_CLK High Period ²	0.5 × t _{SPICLKEXT} – 1		ns
t _{SPICLS} SPIx_CLK Low Period ²	0.5 × t _{SPICLKEXT} – 1		ns
t _{SPICLK} SPIx_CLK Period ²	t _{SPICLKEXT} – 1		ns
t _{HDS} Last SPIx_CLK Edge to $\overline{SPIx_SS}$ Not Asserted	5		ns
t _{SPITDS} Sequential Transfer Delay	t _{SPICLK} – 1		ns
t _{SDSCI} $\overline{SPIx_SS}$ Assertion to First SPIx_CLK Edge	10.5		ns
t _{SSPID} Data Input Valid to SPIx_CLK Edge (Data Input Setup)	2		ns
t _{HSPID} SPIx_CLK Sampling Edge to Data Input Invalid	1.6		ns
<i>Switching Characteristics</i>			
t _{DSOE} $\overline{SPIx_SS}$ Assertion to Data Out Active	0	14	ns
t _{SDHI} $\overline{SPIx_SS}$ Deassertion to Data High Impedance	0	12.5	ns
t _{DDSPID} SPIx_CLK Edge to Data Out Valid (Data Out Delay)		14	ns
t _{HDSPID} SPIx_CLK Edge to Data Out Invalid (Data Out Hold)	0		ns

¹ All specifications apply to all three SPIs.

² This specification indicates the minimum instantaneous width or period that can be tolerated due to duty cycle variation or jitter on the external SPIx_CLK. For the external SPIx_CLK ideal maximum frequency see the $f_{SPICLKTEXT}$ specification in Table 29.

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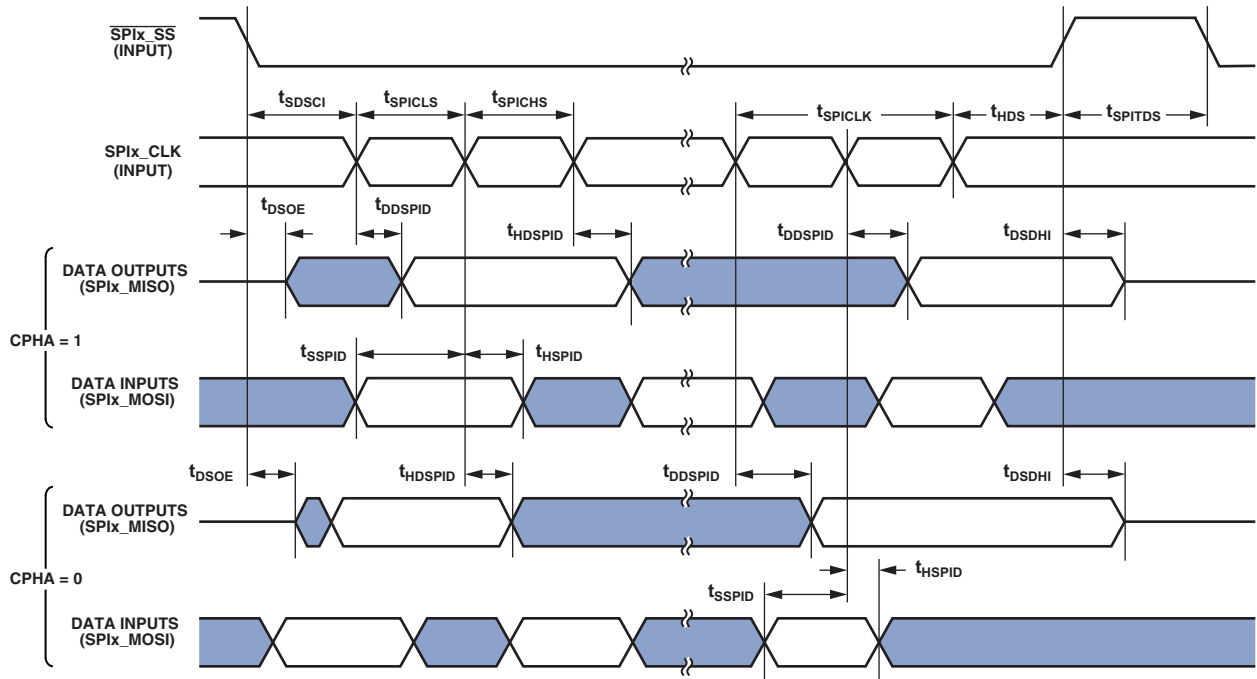


Figure 44. SPI Port—Slave Timing

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Figure 65 and Table 94 show the default I²S justified mode. The frame sync is low for the left channel and high for the right channel. Data is valid on the rising edge of serial clock. The MSB is left justified to the frame sync transition but with a delay.

Table 94. S/PDIF Transmitter I²S Mode

Parameter	Nominal	Unit
<i>Timing Requirement</i>		
t_{I2SD} Frame Sync to MSB Delay in I ² S Mode	1	SCLK

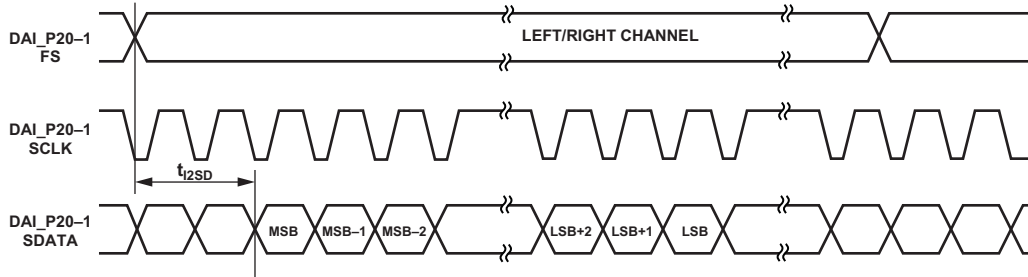


Figure 65. I²S Justified Mode

Figure 66 and Table 95 show the left justified mode. The frame sync is high for the left channel and low for the right channel. Data is valid on the rising edge of serial clock. The MSB is left justified to the frame sync transition with no delay.

Table 95. S/PDIF Transmitter Left Justified Mode

Parameter	Nominal	Unit
<i>Timing Requirement</i>		
t_{LJD} Frame Sync to MSB Delay in Left Justified Mode	0	SCLK

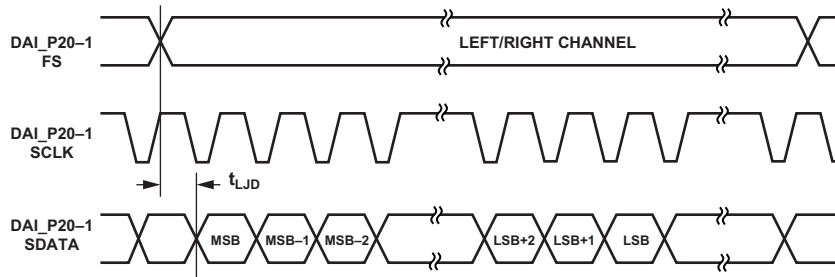


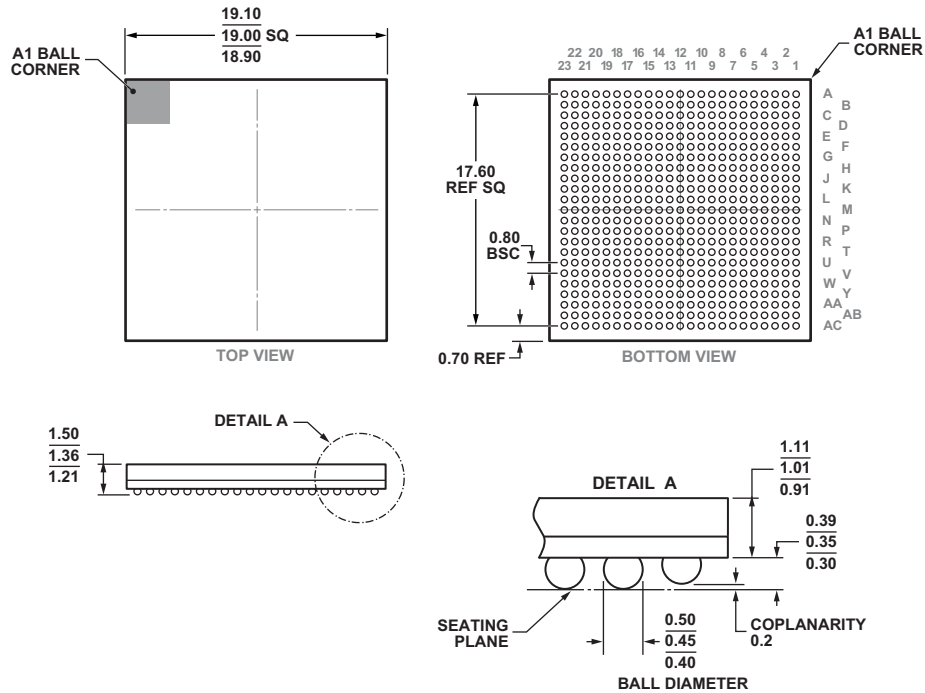
Figure 66. Left Justified Mode

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Pin Name	Ball No.	Pin Name	Ball No.	Pin Name	Ball No.	Pin Name	Ball No.
GND	L16	GND	T08	PA_02	AB23	PC_11	K02
GND	L17	GND	T09	PA_03	AC22	PC_12	L02
GND	M07	GND	T10	PA_04	AB22	PC_13	C20
GND	M08	GND	T11	PA_05	AA20	PC_14	D21
GND	M09	GND	T12	PA_06	AB21	PC_15	E20
GND	M10	GND	T13	PA_07	AC20	PD_00	B22
GND	M11	GND	T14	PA_08	AC21	PD_01	C21
GND	M12	GND	T15	PA_09	AA19	PD_02	F21
GND	M13	GND	T16	PA_10	Y19	PD_03	J19
GND	M14	GND	T17	PA_11	AB20	PD_04	B23
GND	M15	GND	U07	PA_12	Y18	PD_05	C23
GND	M16	GND	U08	PA_13	Y17	PD_06	C22
GND	M17	GND	U09	PA_14	Y16	PD_07	J20
GND	N07	GND	U10	PA_15	AB19	PD_08	E21
GND	N08	GND	U11	PB_00	AA18	PD_09	D23
GND	N09	GND	U12	PB_01	AC19	PD_10	D22
GND	N10	GND	U13	PB_02	AA15	PD_11	E23
GND	N11	GND	U14	PB_03	AA17	PD_12	F23
GND	N12	GND	U15	PB_04	AA16	PD_13	F22
GND	N13	GND	U16	PB_05	Y15	PD_14	E22
GND	N14	GND	U17	PB_06	AA14	PD_15	K20
GND	N15	GND	Y14	PB_07	AA02	PE_00	G23
GND	N16	GND	AC01	PB_08	AA01	PE_01	G22
GND	N17	GND	AC14	PB_09	W02	PE_02	H23
GND	P07	GND	AC23	PB_10	Y02	PE_03	L20
GND	P08	HADC0_VIN0	Y12	PB_11	Y01	PE_04	G20
GND	P09	HADC0_VIN1	AA12	PB_12	W01	PE_05	H22
GND	P10	HADC0_VIN2	AB13	PB_13	V02	PE_06	F20
GND	P11	HADC0_VIN3	AB14	PB_14	T04	PE_07	J23
GND	P12	HADC0_VIN4	V12	PB_15	T02	PE_08	M19
GND	P13	HADC0_VIN5	AA13	PCIE0_CLKM	AC04	PE_09	L22
GND	P14	HADC0_VIN6	W12	PCIE0_CLKP	AC05	PE_10	K23
GND	P15	HADC0_VIN7	Y13	PCIE0_REF	AA07	PE_11	M20
GND	P16	HADC0_VREFN	AB12	PCIE0_RXM	AC03	PE_12	H21
GND	P17	HADC0_VREFP	AC12	PCIE0_RXP	AC02	PE_13	G21
GND	R07	JTG_TCK	P04	PCIE0_TXM	AC07	PE_14	L23
GND	R08	JTG_TDI	P02	PCIE0_TXP	AC06	PE_15	N20
GND	R09	JTG_TDO	P01	PC_00	U03	PF_00	M22
GND	R10	JTG_TMS	N01	PC_01	M01	PF_01	J22
GND	R11	JTG_TRST	N02	PC_02	M03	PF_02	M23
GND	R12	MLB0_CLKN	AB18	PC_03	N04	PF_03	M21
GND	R13	MLB0_CLKP	AC18	PC_04	L01	PF_04	N21
GND	R14	MLB0_DATN	AB17	PC_05	M02	PF_05	N22
GND	R15	MLB0_DATP	AC17	PC_06	K03	PF_06	K22
GND	R16	MLB0_SIGN	AB16	PC_07	L03	PF_07	N23
GND	R17	MLB0_SIGP	AC16	PC_08	J04	PF_08	P20
GND	T03	PA_00	Y20	PC_09	K04	PF_09	L21
GND	T07	PA_01	AA21	PC_10	L04	PF_10	P19

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Dimensions for the 19 mm × 19 mm 529-ball CSP_BGA package in [Figure 101](#) are shown in millimeters.



COMPLIANT TO JEDEC STANDARDS MO-275-RRAB-2.

Figure 101. 529-Ball Chip Scale Package Ball Grid Array [CSP_BGA]
(BC-529-1)
Dimensions shown in millimeters

SURFACE-MOUNT DESIGN

[Table 106](#) is an aid for PCB design. For industry-standard design recommendations, refer to IPC-7351, *Generic Requirements for Surface-Mount Design and Land Pattern Standard*.

Table 106. CSP_BGA Data for Use with Surface-Mount Design

Package	Package Ball Attach Type	Package Solder Mask Opening	Package Ball Pad Size
BC-349-1	Solder Mask Defined	0.4 mm Diameter	0.5 mm Diameter
BC-529-1	Solder Mask Defined	0.4 mm Diameter	0.5 mm Diameter